# PD70100/PD70200

# IEEE® 802.3af/at PD Front End IC

### **Product Overview**

The PD70100 and PD70200 devices are part of Microchip's series of Power over Ethernet (PoE) Powered Device (PD) chips. The PD70100 and PD70200 devices transmit integrated power and analog data in a single 12-pin package. They are used in Powered Devices (PDs), thus enabling next generation network devices to share power and data over the same cable.

Microchip's PD family offers a solution to any PD application compliant with IEEE<sup>®</sup> 802.3af and IEEE 802.3at standards and 4-pairs extra power applications. The IC family's components can be used in both indoor and outdoor applications.

The device family meets all PD-side-standards such as:

- Detection
- Classification
- · Integrated isolation switch with inrush current limiter, and over-current protection
- Two-events classification recognition and AT flag generation (PD70200 only)

In addition, the devices have a discharge mechanism for a DC/DC input capacitor, ensuring quick redetection capability in case the RJ-45 plug is disconnected and reconnected within a short time span.

PD70200 IC design specifically supports IEEE 802.3at standard, including two events classification detection that enables the PD to distinguish whether the connected power source equipment (PSE) is IEEE 802.3at or IEEE 802.3af based.

The PD70200 IC is designed to support 4-pair applications for PDs that require higher power.

## **Features**

- Designed to support IEEE 802.3af and IEEE 802.3at standards
- · PD detection and programmable classification signature
- · Two-events classification flag
- Signature resistor disconnection after detection
- Integrated 0.6  $\Omega$  isolating switch and inrush current limiter
- · 4-pairs support with a single PD70200 IC for up to 48 W
- 4-pairs support with two PD70200 ICs for up to 96 W
- Less than 10 µA offset current during detection
- Single DC voltage input (37 V 57 V)
- Wide operating temperature range: -40 °C to 85 °C
- On-chip thermal protection
- 12-pin 3 mm × 4 mm package
- RoHS compliant
- MSL3

**Table 1. Microchip Powered Device Products Offerings** 

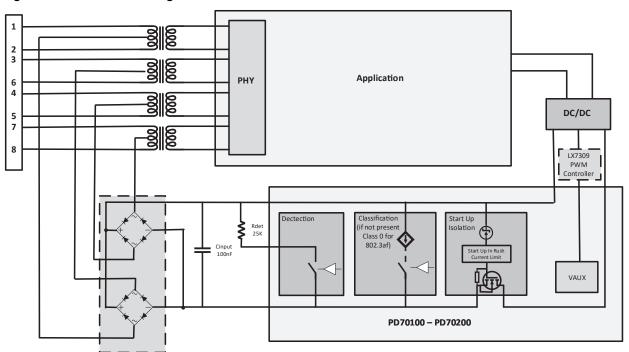
Part	Туре	Package	IEEE 802.3af	IEEE 802.3at	HDBaseT (PoH)	UPoE
PD70100	Front End	3 mm × 4 mm 12L DFN	x	_	_	_
PD70101	Front End + PWM	5 mm × 5 mm 32L QFN	x	_	_	_
PD70200	Front End	3 mm × 4 mm 12L DFN	x	x	_	
PD70201	Front End + PWM	5 mm × 5 mm 32L QFN	x	x	_	_
PD70210	Front End	4 mm × 5 mm 16L DFN	x	x	x	x
PD70210A	Front End	4 mm × 5 mm 16L DFN	x	x	х	x
PD70210AL	Front End	5 mm × 7 mm 38L QFN	x	x	х	x
PD70211	Front End + PWM	6 mm × 6 mm 36L QFN	x	x	x	x
PD70224	Ideal Diode Bridge	6 mm × 8 mm 40L QFN	x	x	х	х

# **Applications**

- Power over Ethernet Powered Devices
- IEEE 802.3af/at 10/100/1000 BASE-T
- 4-pair extra power applications
- Indoor and outdoor applications

The following illustration shows a basic block diagram using PD70100 or PD70200.

Figure 1. Basic PD Block Diagram



Microchip offers complete reference design packages and Evaluation Boards (EVBs). For access to these design packages, device datasheets, or application notes, consult your local Microchip Client Engagement Manager or visit our website at <a href="https://www.microchip.com/poe.">www.microchip.com/poe.</a>. For technical support, consult your local consult your local Embedded Solutions Engineers or go to <a href="https://www.microchip.com/support">www.microchip.com/support</a>. For help in designing the DC/DC portion of your circuit, please try our MPLAB Analog Designer (MAD) tool at <a href="https://www.microchip.com/mad-poe">www.microchip.com/mad-poe</a>.

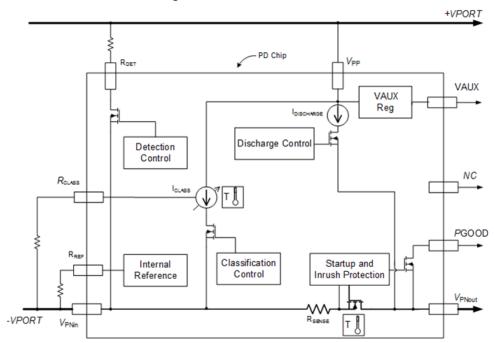
# **Table of Contents**

Pro	oduct Overview	
	Features	1
	Applications	2
1.	Functional Descriptions	5
	1.1. Detail Description	
2.	Electrical Specifications	9
	2.1. Absolute Maximum Ratings	9
	2.2. Typical Electrical Performance	9
	2.3. Pin Description	13
3.	Package Specifications	15
	3.1. Package Outline Drawing	15
	3.2. Thermal Specifications	16
	3.3. Recommended PCB Layout	17
4.	Ordering Information	21
5.	References	22
6.	Revision History	23
The	e Microchip Website	24
Pro	oduct Change Notification Service	24
Cus	stomer Support	24
Mic	crochip Devices Code Protection Feature	24
Leç	gal Notice	25
Tra	ademarks	25
Qua	uality Management System	26
Wo	orldwide Sales and Service	27

# 1. Functional Descriptions

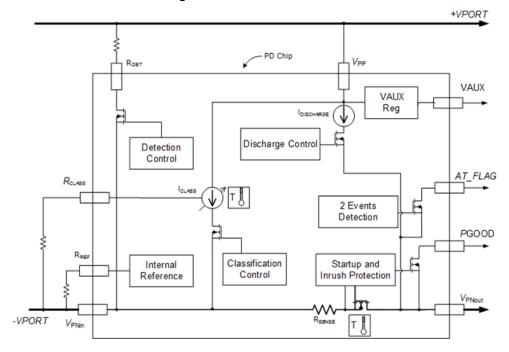
The following illustration shows the functional blocks of the PD70100.

Figure 1-1. PD70100 Functional Block Diagram



The following illustration shows the functional blocks of the PD70200.

Figure 1-2. PD70200 Functional Block Diagram



## 1.1 Detail Description

PD70100/PD70200 IC provides IEEE 802.3af/at compliant PD Front-End functions including Detection, Physical Layer Classification, Two-Events Classification (PD70200 only), Auxiliary Voltage Output, Power Good, Soft Start Current Limiting, Over-Current Protection, and Bulk Capacitor Discharge.

#### 1.1.1 Detection

IEEE 802.3af/at compliant detection is provided by a 24.9 K $\Omega$  resistor connected between V<sub>PP</sub> and R<sub>DET</sub> pin. R<sub>DET</sub> pin is connected to VPN<sub>IN</sub> via an open drain MOSFET with a maximum specified RDS<sub>ON</sub> of 50  $\Omega$ . Internal logic monitors V<sub>PP</sub> to VPN<sub>IN</sub> and connects the R<sub>DET</sub> pin to VPN<sub>IN</sub> when the rising V<sub>PP</sub> to VPN<sub>IN</sub> voltage is between 2.5 V and 10.1 V. When rising V<sub>PP</sub> to VPN<sub>IN</sub> voltage exceeds 10.1 V, the MOSFET is switched off. Once above 10.1 V, falling V<sub>PP</sub> to VPN<sub>IN</sub> voltage between 2.45 V and 4.85 V will reconnect R<sub>DET</sub> pin to VPN<sub>IN</sub>.

#### 1.1.2 Physical Layer Classification

Physical Layer (hardware) Classification per IEEE 802.3af/at is generated via a regulated reference voltage of 1.2 V, switched onto the  $R_{CLASS}$  pin. Internal logic monitors the  $V_{PP}$  to  $VPN_{IN}$  voltage and connects the 1.2 V reference to  $R_{CLASS}$  pin at a rising  $V_{PP}$  to  $VPN_{IN}$  voltage threshold between 11.1 V and 13.5 V. Once  $V_{PP}$  to  $VPN_{IN}$  has exceeded the rising threshold, there is a 1 V minimum hysteresis between the  $V_{PP}$  rising (turn-on) threshold and the  $V_{PP}$  falling (turn-off) threshold.

The 1.2 V reference stays connected to the  $R_{CLASS}$  pin until the  $V_{PP}$  to  $VPN_{IN}$  rising voltage exceeds the upper turn-off threshold of 20.9 V to 23.9 V. The 1.2 V reference voltage is disconnected from the  $R_{CLASS}$  pin at  $V_{PP}$  to  $VPN_{IN}$  voltages above the upper threshold.

Classification current signature is provided via a resistor connected between  $R_{CLASS}$  pin and  $VPN_{IN}$ . The classification current is therefore the current drawn by the PD70100/PD70200 IC during the classification phase, and is simply the 1.2 V reference voltage divided by the  $R_{CLASS}$  resistor value. The maximum current available at the  $R_{CLASS}$  pin is current limited to 55 mA (typical).

#### 1.1.3 Two-Events Detection and AT Flag

The PD70200 IC provides IEEE 802.3at Type 2 compliant detection of the "Two Events Classification Signature", and generation of the AT flag. This feature is available on the PD70200 IC only.

Simply put, the "Two Events Classification Signature" is a means by which an IEEE 802.3at Type 2 Power Source can inform a compliant Power Device (PD) that it is AT Type 2 compliant, and as such is capable of providing AT Type 2 power levels.

The Power Source communicates with a Type 2 compliant signature by toggling the  $V_{PP}$  to  $VPN_{IN}$  voltage twice (2 "events") during the Physical Layer Classification phase. The  $V_{PP}$  to  $VPN_{IN}$  voltage is toggled from the Physical Layer Classification's voltage level (13.5 V to 20.9 V) down to a voltage "Mark" level. Voltage "Mark" level is specified as a  $V_{PP}$  to  $VPN_{IN}$  voltage of 4.9 V to 10.1 V.

PD70200 IC recognizes a  $V_{PP}$  to  $VPN_{IN}$  falling edge from Classification level to Mark level as being one event of the Two-Events Signature. If two such falling edges are detected, PD70200 will assert AT flag by means of an open drain MOSFET connected between AT\_FLAG pin and  $VPN_{OUT}$ .

AT\_FLAG pin is active low; a low impedance state between AT\_FLAG and VPN<sub>OUT</sub> indicates a valid Two-Events Classification Signature was received, and the Power Source is AT Type 2 compliant.

AT\_FLAG MOSFET is capable of 5 mA of current and can be pulled up to V<sub>PP</sub>.

#### 1.1.4 Soft Start and Inrush Current Protection

PD70100/PD70200 IC contains an internal isolation switch, that provides ground isolation between Power Source and PD application during Detection and Classification phases. The isolation switch is a N-channel MOSFET, wired in a common source configuration where the MOSFET's Source is connected to Power Source ground at VPN<sub>IN</sub>, and the MOSFET's Drain is connected to application's primary ground at VPN<sub>OIT</sub>.

Internal logic monitors  $V_{PP}$  to  $VPN_{IN}$  voltage and keeps the MOSFET in a high impedance state until  $V_{PP}$  to  $VPN_{IN}$  voltage reaches turn-on threshold of 36 V to 42 V. Once  $V_{PP}$  to  $VPN_{IN}$  voltage exceeds this threshold, the MOSFET is switched into one of two modes.

The mode into which the MOSFET is switched is determined by the voltage developed across the MOSFET, or put another way, the VPN<sub>OUT</sub> to VPN<sub>IN</sub> differential voltage. Two modes are defined below:

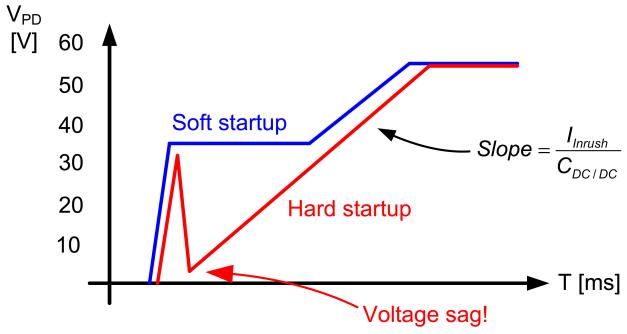
**Table 1-1. Isolation Switch Modes** 

VPN <sub>OUT</sub> to VPN <sub>IN</sub>	Mode	Description				
>0.7 V	Soft Start Mode	Limits VPN <sub>OUT</sub> current to 240 mA (typical)				
≤0.7 V	Normal Operating Mode	Limits VPN <sub>OUT</sub> current to 1.8 A (typical)				

By controlling the MOSFET current based on  $VPN_{OUT}$  to  $VPN_{IN}$  voltage, inrush currents generated by fully discharged bulk capacitors can be limited. This method limits current to a maximum of 350 mA, compliant with IEEE 802.3af/at specification.

Soft Start current limiting is required to reduce occurrences of voltage sag at the PD input during device power-up. A comparison is shown in the following figure.

Figure 1-3. Startup Comparison



Once bulk capacitance has charged up to a point where  $VPN_{OUT}$  to  $VPN_{IN}$  differential voltage is less than 0.7 V, the isolation MOSFET is switched into normal operating mode with MOSFET current limit set at 1.8 A (typical), to provide over-current protection.

PD70100 and PD70200 ICs are different in their respective isolation MOSFET's continuous current handling capability:

- PD70100: 450 mA (max.)
- PD70200: 1123 mA (max.)

An adequate heat sink for the PD70100/PD70200 IC's exposed pad must be provided to achieve these current levels without damaging the IC. A large, heavy copper fill area and/or a heavy ground plane with Thermal Vias is recommended. Electrically the exposed pad ground plane should be connected to VPN<sub>IN</sub>.

Internal logic monitoring  $V_{PP}$  to  $VPN_{IN}$  will place the isolation switch MOSFET in a high impedance state if voltage between  $V_{PP}$  and  $VPN_{IN}$  drops below 31 V to 34 V.

## 1.1.5 Over-Current Protection

Over-current protection is provided on the PD70100/PD70200 IC using the Isolation MOSFET Switch, which limits the VPN<sub>OUT</sub> current to 1.8 A during normal operation. See previous description of Soft Start.

#### 1.1.6 Power Good

During Soft Start mode, the PD70100/PD70200 IC monitors  $VPN_{OUT}$  to  $VPN_{IN}$  differential voltage. When this voltage is less than 0.7 V (max.), the IC enters normal operation mode and the isolation switch current limit is increased to 1.8 A (typical). At this same 0.7 V (max.) threshold the Power Good signal is asserted by means of an open drain MOSFET between PGOOD and  $VPN_{OUT}$ .

PGOOD pin is active low; a low impedance state between PGOOD and VPN<sub>OUT</sub> indicates the Soft Start mode has finished and the isolation switch has transitioned into normal operating mode.

PGOOD MOSFET can handle current of 5 mA and can be pulled up to V<sub>PP</sub>.

#### 1.1.7 Auxiliary Voltage Output

PD70100/PD70200 IC provides a 10.5 V (typical) regulated output to be used as a start-up supply for DC/DC controllers whose  $V_{CC}$  is provided via a bootstrap winding. This regulated supply is available at  $V_{AUX}$  pin, and is referenced to VPN<sub>OUT</sub> pin.  $V_{AUX}$  supply is designed for low-duty operation, and should not be designed as a primary housekeeping supply. The current capability is continuous 2 mA, with 10 mA peak ( $\leq$ 10 ms).  $V_{AUX}$  output is current-limited at 10 mA (min.).

For stability, the  $V_{AUX}$  regulator requires a minimum of 4.7  $\mu$ F ceramic capacitor connected directly between  $V_{AUX}$  and  $VPN_{OUT}$  pins.

#### 1.1.8 Thermal Protection

Both PD70100 and PD70200 IC include temperature sensors which individually monitor both the isolation MOSFET and the Classification Current Source for over temperature conditions. In case of an over temperature condition, the sensor will activate protection circuitry which will disconnect its respective monitored function.

#### 1.1.9 Bulk Capacitor Discharge

The bulk capacitor discharge circuitry eliminates the need to place a diode in series with the  $V_{PP}$  line to prevent an application's bulk capacitance from discharging through the detection resistor and the isolation switch MOSFET's body diode. Discharge current through the detection resistor can cause failure of the detection signature in cases where a PD is connected and the bulk capacitance is not fully discharged.

During normal operation, PD70100/PD70200 IC continuously monitors voltage at  $V_{PP}$  to  $VPN_{IN}$ . Should  $V_{PP}$  to  $VPN_{IN}$  voltage fall below isolation switch turn-off threshold (31 V to 34 V), isolation switch MOSFET is immediately placed in a high-impedance state. At this point the internal logic monitors the voltage at  $V_{PP}$  to  $VPN_{OUT}$ . If  $V_{PP}$  to  $VPN_{OUT}$  voltage is between 1.5 V to 32 V, a 23 mA (min.) constant current source is connected across the  $V_{PP}$  and  $VPN_{OUT}$  pins. This constant current source provides bulk capacitor discharge.

A 220 µF bulk capacitance can be discharged from 32 V to 1.5 V in a maximal period of 292 ms.

# 2. Electrical Specifications

## 2.1 Absolute Maximum Ratings

Table 2-1. Absolute Maximum Ratings<sup>2, 3</sup>

Parameter	Description
Supply Input Voltage (V <sub>PP</sub> ) Continuous	-0.3 V to 74 V <sub>DC</sub>
Supply Input Voltage (V <sub>PP</sub> ) 1 ms pulse	-0.3 V to 88 V <sub>DC</sub>
Port Negative Out Voltage (VPN <sub>OUT</sub> )	-0.3 V to 74 V <sub>DC</sub>
R <sub>DET</sub> Continuous	-0.3 V to 74 V <sub>DC</sub>
R <sub>DET</sub> 1 mS pulse	-0.3 V to 88 V <sub>DC</sub>
R <sub>CLASS</sub> , R <sub>REF</sub>	-0.3 V to 5 V <sub>DC</sub>
V <sub>AUX</sub>	-0.3 V to 30 V <sub>DC</sub>
PGOOD, AT_FLAG (with respect to VPN <sub>OUT</sub> ) Continuous	-0.3 V to 74 V <sub>DC</sub>
PGOOD, AT_FLAG (with respect to VPN <sub>OUT</sub> ) 1 mS pulse	-0.3 V to 88 V <sub>DC</sub>
ESD Protection <sup>1</sup>	±1.5 kV HBM
Maximum Operating Junction Temperature (T <sub>A</sub> )	150 °C
Operating Ambient Temperature	-40 °C to 85 °C
Storage Temperature Range	−65 °C to 150 °C
Peak Package Solder Reflow Temp (40 seconds max exposure)	260 °C

- 1. All pins except pin 11 (V<sub>AUX</sub>). Pin 11 ESD Protection ±150 V HBM.
- 2. No pin voltage can be higher than  $V_{PP}$ .
- 3. Exceeding these ratings could cause damage to the device. All voltages are with respect to VPN<sub>IN</sub> except for Vaux, PGOOD and AT\_FLAG with respect to VPN<sub>OUT</sub>. Currents are positive into, negative out of specified terminal. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" are not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

## 2.2 Typical Electrical Performance

Unless otherwise specified, the following specifications apply over the operating ambient temperature  $-40 \, ^{\circ}\text{C} \le T_{\text{AMB}} \le 85 \, ^{\circ}\text{C}$ . Production tests are done at 25  $^{\circ}\text{C}$   $T_{\text{A}}$ .

### 2.2.1 Power Supply

Table 2-2. Power Supply

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
Input Voltage	V <sub>PP</sub>	0	55	57	V	Supports full IEEE 802.3af/at functionality
Power Supply Current at Operating Mode	_	_	1	3	mA	V <sub>PP</sub> = 55 V

## 2.2.2 Detection Mode

## **Table 2-3. Detection Mode**

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/Comment
Detection is connected.  At this voltage range R <sub>DET</sub> must be on.	DET <sub>RANGE</sub>	1.3	_	10.1	V	Measured between V <sub>PP</sub> and VPN <sub>IN</sub>
Detection Switch ON Resistance PD-detection	R <sub>DET</sub> -on	_	_	50	Ω	2.5 V ≤ ( $\Delta$ V <sub>PP</sub> to VPN <sub>IN</sub> ) ≤ 10.1 V Measured between R <sub>DET</sub> and VPN <sub>IN</sub>
Detection is Disconnected	R <sub>DET</sub> -off	10.1	_	12.8	V	Measured between V <sub>PP</sub> and VPN <sub>IN</sub>
Detection Switch OFF Resistance	R <sub>DET</sub> -off	2.0	_	_	ΜΩ	12.8 V $\leq$ ( $\Delta$ V <sub>PP</sub> to VPN <sub>IN</sub> ) $\leq$ 57.0 V Measured between R <sub>DET</sub> and VPN <sub>IN</sub>
Input Offset Current	I <sub>OFFSET</sub>	_	_	16	μΑ	1.1 V to 10.1 V -40 °C ≤ T <sub>J</sub> ≤ 85 °C
	I <sub>OFFSET</sub>	_	_	10	μΑ	1.1 V to 10.1 V -40 °C ≤ T <sub>J</sub> ≤ 55 °C

## 2.2.3 Classification Mode

### Table 2-4. Classification Mode

Parameter	Symbol	Min	Тур	Max	Units	Test Condition/ Comment
Classification Current Source, Turn ON	V <sub>TH</sub> low-on	11.4	_	13.7	V	Turn on for any I <sub>CLASS</sub> while V <sub>PP</sub> increases
Threshold Range Measured at V <sub>PP</sub>						liicieases
Classification Current Source, Turn OFF $ \label{eq:continuous} $ ThresholdRangeMeasured at $V_{PP}$	V <sub>TH</sub> high-off	20.9	_	23.9	V	Turn off while V <sub>PP</sub> increases
Current Limit Threshold	I <sub>CLASS</sub> LIM	50.0	68	80.0	mA	_
Input Current I <sub>PP</sub> When Classification Function is Disabled	I <sub>CLASS</sub> DIS	_	_	4.0	mA	Class 0  R <sub>CLASS</sub> =  Disconnect

continued									
Parameter	Symbol	Min	Тур	Max	Units	Test Condition/ Comment			
Input Current I <sub>PP</sub> When Classification Function is Enabled	I <sub>CLASS</sub> EN	9.0	10.5	12.0	mA	Class 1 R <sub>CLASS</sub> = 133 Ω ±1%			
		17.0	18.5	20.0	mA	Class 2 $R_{CLASS} = 69.8 \Omega$ ±1%			
		26.0	28.0	30.0	mA	Class 3 $R_{CLASS} = 45.3 \Omega$ ±1%			
		36.0	40.0	44.0	mA	Class 4 $R_{\text{CLASS}} = 30.9 \Omega$ $\pm 1\%$			

## 2.2.4 Mark

## Table 2-5. Mark

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
Mark, Working Voltage Range	V <sub>MARK</sub>	4.9	_	10.1	V	When voltage decreases Measured between $V_{PP}$ to $VPN_{IN}$
Mark Current	I <sub>MARK</sub>	0.25	_	4	mA	Chip current

## 2.2.5 Isolation Switch

## Table 2-6. Isolation Switch

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
Isolation Switch MOSFET Switches from Off to I <sub>LIM-LOW</sub>	V <sub>SW-START</sub>	36	_	42	V	_
Isolation Switch MOSFET Switched Off	V <sub>SW-OFF</sub>	30.5	_	34.5	V	_
Startup Current Limit, I <sub>LIM</sub>	I <sub>LIM-LOW</sub>	105	240	325	mA	_
$\rm VPN_{IN}$ to $\rm VPN_{OUT}$ Threshold Voltage for $\rm I_{LIM\text{-}LOW}$ to $\rm I_{LIM\text{-}HIGH}$ Switchover	V <sub>DIFF</sub>	_	_	0.7	V	When VPN <sub>IN</sub> to VPN <sub>OUT</sub> $\leq$ V <sub>DIFF</sub> , Isolating switch switches over from $I_{LIM-LOW}$ to $I_{LIM-HIGH}$
Over Current Protection Current Limit	OCP	1500	1800	2000	mA	_

continued										
Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment				
Continuous Operation Load Current (PD70100)	I <sub>LOAD</sub>	_	350	450	mA	Isolating switch at I <sub>LIM</sub> - нібн				
Continuous Operation Load Current (PD70200)		_	600	1123						
Continuous Operation Total RDS <sub>ON</sub>	SW-RDS <sub>ON</sub>	_	_	0.6	Ω	Total resistance between VPN <sub>IN</sub> and VPN <sub>OUT</sub> Isolating switch at I <sub>LIM-HIGH</sub>				

## 2.2.6 DC/DC Capacitor Discharger

## Table 2-7. DC/DC Capacitor Discharger

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
DC/DC Input Capacitance	_	_	220	_	μF	For reference only Guaranteed by design (not tested in production)
Discharge Current	_	22.8	32	50	mA	$7.0 \text{ V} \le \text{V}_{PP} \text{ to}$ VPN <sub>OUT</sub> $\le 30 \text{ V}$
Full Discharge Time for Full Discharge of Input Capacitance	T <sub>DSC</sub>	_	_	500	ms	V <sub>PP</sub> < UVLO threshold Guaranteed by design (not tested in production)

## 2.2.7 AT\_FLAG

## Table 2-8. AT\_FLAG

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
Output Low Voltage	_	_	_	0.4	V	I <sub>OL</sub> = 0.75 mA
	_	_	_	2.5	V	I <sub>OL</sub> MAX = 5 mA
Leakage Current	_	_	_	1.7	μΑ	V <sub>ATFLAG</sub> = 57 V

## 2.2.8 **PGOOD**

## Table 2-9. PGOOD

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/Comment
Output Low Voltage	_	_	_	0.4	μF	I <sub>OL</sub> = 0.75 mA
		_	_	2.5	mA	I <sub>OL</sub> MAX = 5 mA
Leakage Current	_	_	_	1.7	μΑ	V <sub>PGOOD</sub> = 57 V

### 2.2.9 Thermal Shutdown

### Table 2-10. Thermal Shutdown

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/ Comment
Thermal Shutdown Temperature	_	180	200	220	°C	_

#### 2.2.10 VAUX

Reference to VPN<sub>OUT</sub>.

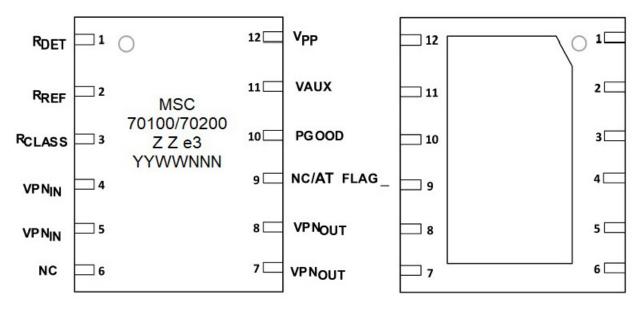
Table 2-11. VAUX

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions/Comment
V <sub>AUX</sub> Output Voltage On	V <sub>AUX-on</sub>	9.5	10.5	11.8	V	Isolating switch at I <sub>LIM-HIGH</sub> and PGOOD = Low
Output Current Peak	I <sub>VAUXP</sub>	0	_	10	mA	Capacitor = 30 $\mu$ F When T <sub>LOAD</sub> $\leq$ 5 mS Isolating switch at I <sub>LIM-HIGH</sub> and PGOOD = Low
Output Continuous Current	I <sub>VAUXC</sub>	0	_	2	mA	When T <sub>LOAD</sub> ≤ 10 mS Isolating switch at I <sub>LIM-HIGH</sub> and PGOOD = Low
V <sub>AUX</sub> Output Current Limit	I <sub>VAUX</sub>	10	_	32	mA	Isolating switch at I <sub>LIM-HIGH</sub> and PGOOD = Low

## 2.3 Pin Description

The following illustration shows the device pinout, from the top view and bottom view.

Figure 2-1. Pinout Top View and Bottom View



The following table lists the pin descriptions for the PD70100/PD70200 devices.

## Table 2-12. Pin Descriptions

Pin	Pin Name (PD70100)	Pin Name (PD70200)	Туре	Description
1	R <sub>DET</sub>	R <sub>DET</sub>	_	Valid Detection resistor. Connect external 24.9 $K\Omega$ detection resistor between $R_{DET}$ and $V_{PP}$ .
2	R <sub>REF</sub>	R <sub>REF</sub>	_	Bias current resistor. Connect a 243 k 1% resistor between this pin and $\mbox{VPN}_{\mbox{IN}}$ .
3	R <sub>CLASS</sub>	R <sub>CLASS</sub>	_	Power classification setting. Connect external class resistor between $R_{\text{CLASS}}$ and $VPN_{\text{IN}}$ .
4	VPN <sub>IN</sub>	VPN <sub>IN</sub>	Power	V <sub>Port</sub> Negative input. Connected to the
5				isolating SW input. N-channel MOSFET source. The exposed thermal pad should be connected to these pins.
6	N.C.	N.C.	_	_
7	VPN <sub>OUT</sub>	VPN <sub>OUT</sub>	Power/Gnd	Vport Negative output. Connected to
8				the isolating SW output. N-channel MOSFET Drain. Primary side Ground.
				A decent ground plane should be deployed around this pin whenever is possible.
9	N.C.	AT_FLAG	Open drain	The two-event detector should discern between AF and AT classification waveforms and outputs the AT_FLAG (PD70200 only).
10	PGOOD	PGOOD	Open drain	After startup, a PGOOD flag is generated in order to optionally inform the application DC/DC converter that the power rails are ready.
11	V <sub>AUX</sub>	V <sub>AUX</sub>	Power	Auxiliary output voltage to VPN <sub>OUT</sub> . Can be used for DC-DC startup for bootstrap initiation.
12	V <sub>PP</sub>	$V_{PP}$	Power	High voltage positive input, reference to VPN <sub>IN</sub> and high voltage positive input, reference to VPN <sub>OUT</sub> during capacitor discharge.
EP	EPAD	EPAD	_	Connect to VPN <sub>IN</sub> . EPAD should be connected to a large copper area for improved thermal management.

# 3. Package Specifications

This section provides information about the available package.

## 3.1 Package Outline Drawing

Figure 3-1. Package Drawing Dimensions and Measurements

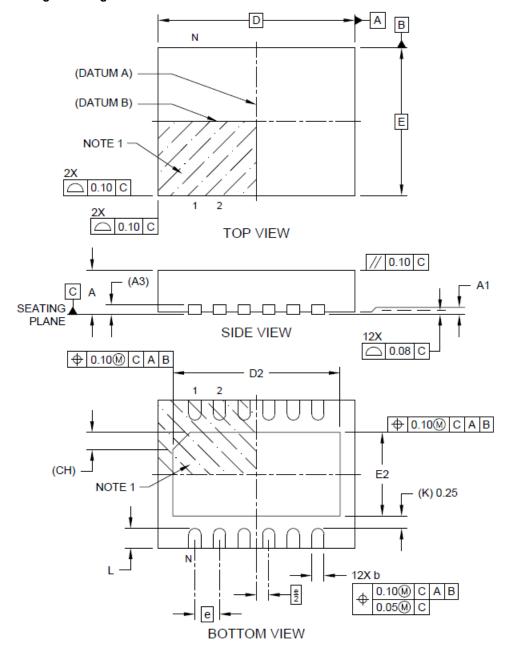


Table 3-1. Package Dimensions: DFN<sup>1, 2, 3, 4</sup>

Units	Millimeters				
Dimension Limits	Min.	Nom.	Max.		
Number of Terminals	N	12	•		
Pitch	е	0.05 BSC			
Overall Height	Α	0.80	0.90	1.0	
Standoff	A1	0.00	0.02	0.05	
Terminal Thickness	A3	0.20 REF			
Overall Length	D	4.00 BSC			
Exposed Pad Length	D2	3.30	3.40	3.50	
Overall Width	E	3.00 BSC			
Exposed Pad Width	E2	1.60	1.70	1.80	
Terminal Width	b	0.20	0.25	0.30	
Terminal Length	L	0.30	0.40	0.50	
Terminal-to-Exposed-Pad	K	0.25 REF			
Index Chamfer	СН	0.35 REF			

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
  - a. BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - b. REF: Reference Dimension, usually without tolerance, for information purposes only.
- For the most current package drawings, please see the Microchip Packaging Specification located at www.microchip.com/packaging.

## 3.2 Thermal Specifications

The following table lists the thermal specifications for the PD70100 and PD70200 devices.

**Table 3-2. Thermal Specifications** 

Parameter	Value
Typical thermal resistance: junction to ambient	40 °C/W
Typical thermal resistance: junction to case	4 °C/W

The  $\theta_{JA}$  numbers are guidelines for the thermal performance of the device/pc-board system. All specifications assume no ambient airflow.

## 3.3 Recommended PCB Layout

The following figures show the PD70100/PD70200 PCB layout based on the IPC7093A October 2020 standard. All previously published footprints are still supported.

Figure 3-2. Solder Mask (Top View)

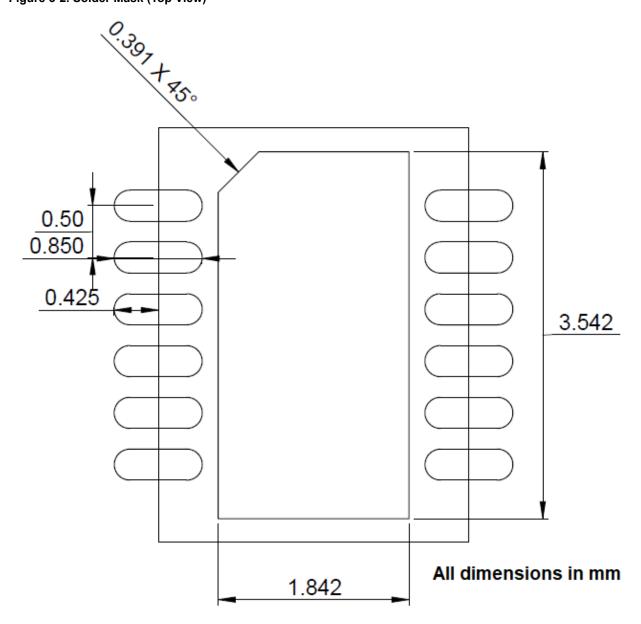


Figure 3-3. Copper Layer (Top View)

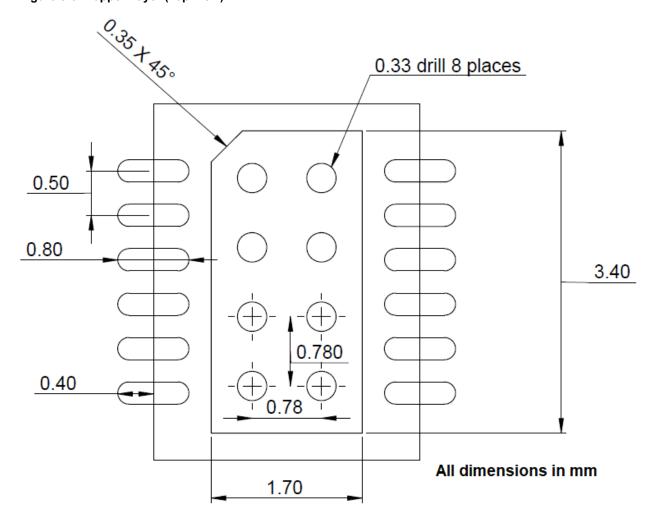
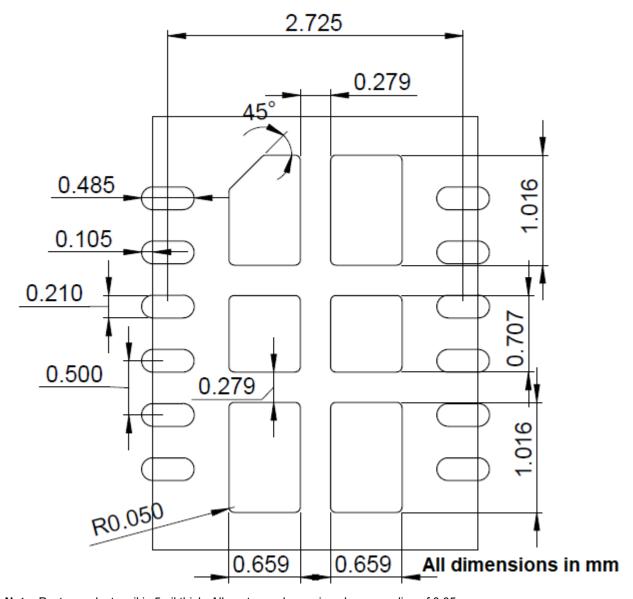
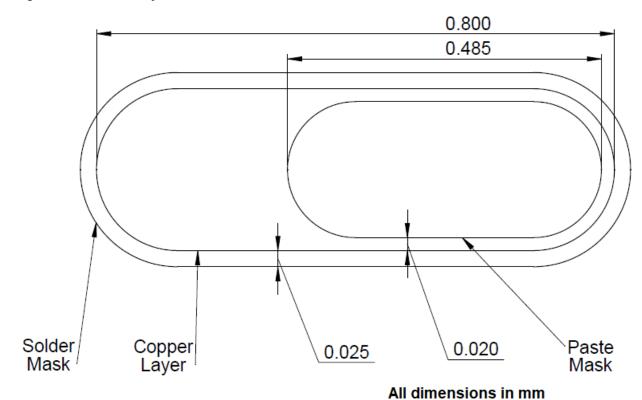


Figure 3-4. Paste Mask (Top View)



 $\textbf{Note:} \ \mathsf{Paste} \ \mathsf{mask} \ \mathsf{stencil} \ \mathsf{is} \ \mathsf{5mil} \ \mathsf{thick.} \ \mathsf{All} \ \mathsf{paste} \ \mathsf{mask} \ \mathsf{openings} \ \mathsf{have} \ \mathsf{a} \ \mathsf{radius} \ \mathsf{of} \ \mathsf{0.05} \ \mathsf{mm}.$ 

Figure 3-5. Pin Geometry



# 4. Ordering Information

Table 4-1. Ordering Information

Part Number	Packaging Type	Package	Part Marking
PD70100ILD-TR	Tape and Reel	DFN	MSC
		4 mm × 3 mm	70100
		12 pins	Z Z e3 <sup>1</sup>
		RoHS Compliant/Pb-free	YYWWNNN <sup>2</sup>
PD70200ILD-TR	Tape and Reel	DFN	MSC
		4 mm × 3 mm	70200
		12 pins	Z Z e3 <sup>1</sup>
		RoHS Compliant/Pb-free	YYWWNNN <sup>2</sup>

- 1. ZZ e3: ZZ = Random Character with no meaning, and e3 = 2nd level interconnect.
- 2. YY = Year, WW = Week, NNN = Trace Code.

## 5. References

- AN3551 PD70101 and PD70201 PD Device Layout Guidelines
- AN3471 Designing a Type 1/2 802.3 or HDBaseT Type 3 Powered Device Using PD702x1 and PD701x1 ICs
- AN3472 Implementing Auxiliary Power in PoE

# 6. Revision History

Revision	Date	Description
В	07/2021	<ul> <li>Updated section Package Outline Drawing.</li> <li>Added section Recommended PCB Layout.</li> </ul>
		Added Section Recommended PCB Layout.
Α	11/2020	<ul> <li>Updated to Microchip template.</li> <li>Updated document number from PD-000303241 to DS00003639.</li> <li>Added Microchip Powered Device Products Offerings table.</li> <li>Updated Figure 1.</li> <li>Added References section.</li> </ul>
4.0	08/2019	<ul> <li>The package marking details were updated in the ordering information table.</li> <li>Figure 1 and Figure 4 were updated.</li> </ul>
3.0	01/2018	<ul> <li>The formatting of this document was updated to the latest template.</li> <li>MSL level was updated.</li> <li>Part marking was updated.</li> <li>Absolute Maximum Ratings were updated.</li> </ul>
2.0	10/2015	The IC part number was updated from PD70100A to PD70100 (PDN 152044).
1.1	10/2014	The description of Pin 2 was updated.
1.0	03/2012	<ul><li>The document address footer was updated.</li><li>Characteristics were updated.</li></ul>
0.6	07/2011	The specification was updated.
0.5	01/2011	Package was updated.
0.4	12/2010	Package was updated.
0.3	11/2010	<ul> <li>Classification Pulse diagrams were added.</li> <li>Catalog numbers metrology was changed.</li> <li>Extensive changes were made to document format and Theory of Operation section.</li> <li>Package drawing was corrected.</li> <li>Product Highlight and Typical Characteristics were added.</li> </ul>
0.1	04/2010	Initial Revision

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